



QForm Seminar. Hanoi 20 March 2018

Metal forming and profile extrusion simulation. Effective solutions and latest developments

We are glad to invite all QForm users as well as everybody who is interested in metal forming and profile extrusion simulation from around the world to participate in seminar which will take place on 20 March 2018 in Hanoi University of Industry in Hanoi, Vietnam.

PRELIMINARY PROGRAM

9:00	Welcome of participants <i>Mr. Canh Nguyen Van, General Manager, BKTechBrigde. JSC</i>
9:15	QForm – Metal Forming Simulation Software <i>Mr. Paul Mordvintsev, Head of Business Development Department, QForm Group</i>
9:45	New possibilities of QForm VX 8.2, Tool wear analysis, Defects prediction <i>Mr. Paul Mordvintsev</i>
10:15	The use of advanced simulation in QForm for design of forging processes <i>Mr. Paul Mordvintsev</i>
10:45	Coffee break
11:15	Effective design of aluminum profile extrusion technology using QForm Extrusion software <i>Mr. Paul Mordvintsev</i>
11:30	Quality prediction and improvement of extruded profiles by means of simulation <i>Mr. Paul Mordvintsev</i>
12:00	Discussion and questions
13:00	Lunch
14:00	Individual demonstration, training and discussion

Location and contacts:

Hanoi University of Industry
Conference Room, 2nd Floor, A7 Building,
No. 298 Cau Den Str., Bac Tu Liem Dist.
Hanoi City, Vietnam

For registration of participants fill the form at:

www.qform3d.com/register/hanoi

Or send an email to

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Cost of participation: FREE

Recommendation:

For more effective participation in QForm Forum, please, bring your laptop with you to be able to simulate interesting projects in new QForm VX 8.2 during event and to get new QForm simulation skills.

This leaflet is provided for general information purposes only and may be subject to change without notice.

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